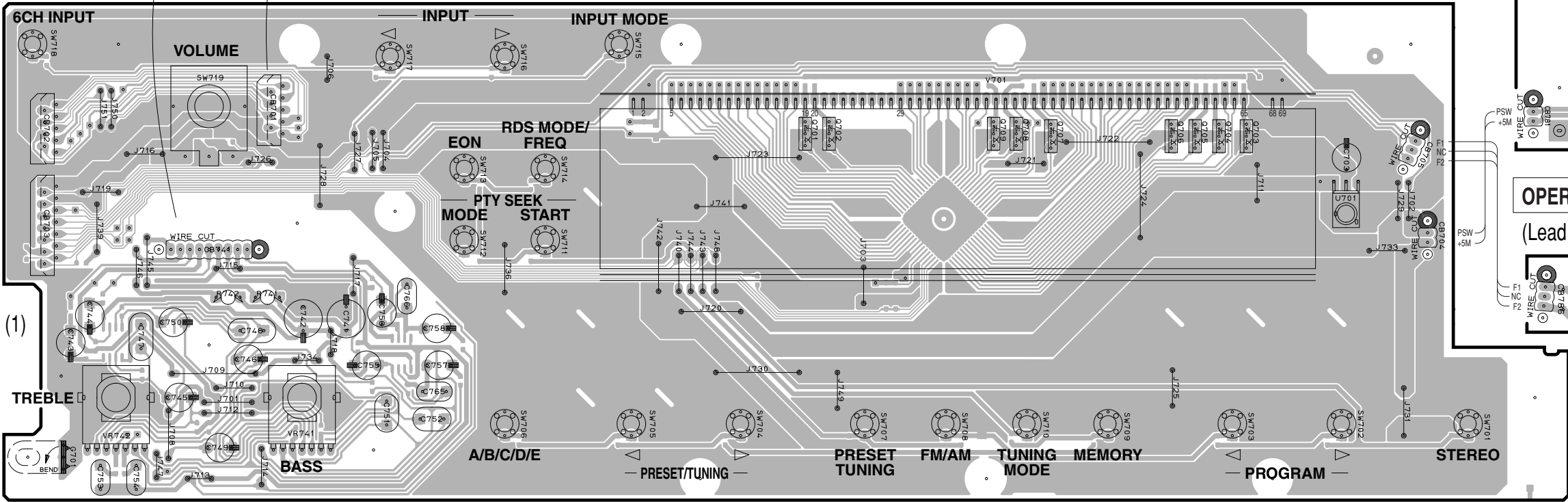


PRINTED CIRCUIT BOARD (Foil side)

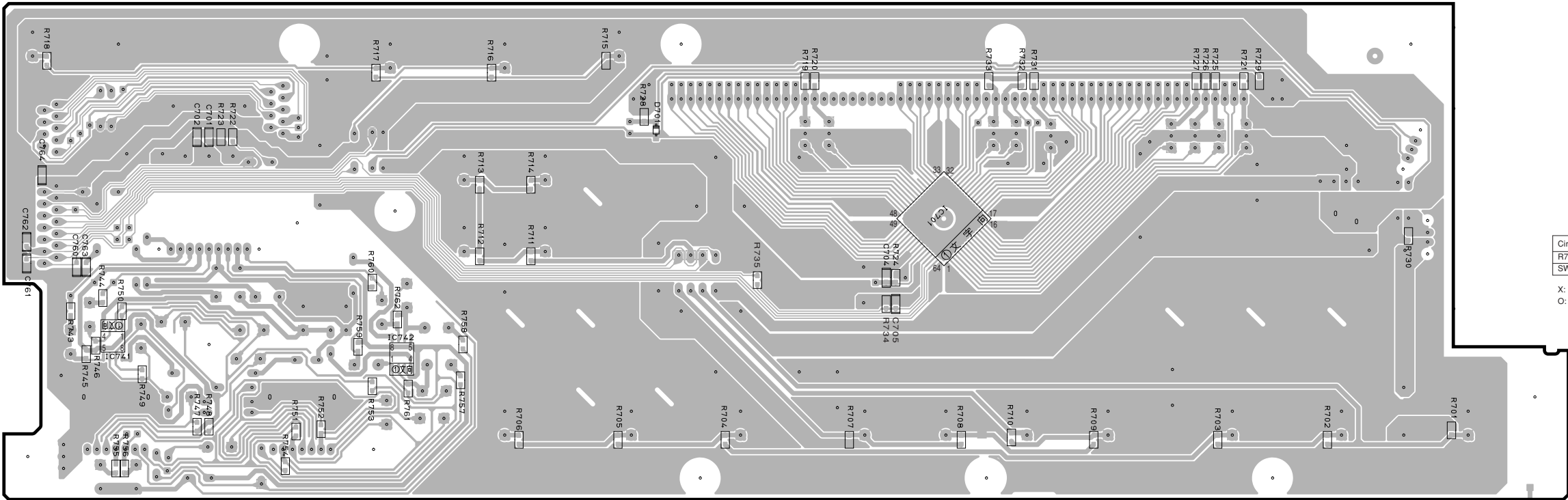
OPERATION (1) P. C. B. (Lead Type Device)

OPERATION (2) P. C. B. (Lead Type Device)

OPERATION (3) P. C. B. (Lead Type Device)



OPERATION (1) P. C. B. (Surface Mount Device)



Semiconductor Location

Ref. No.	Location
D701	D5
IC701	F6
IC741	B6
IC742	C6
Q701	E3
Q702	E3
Q703	G3
Q704	G3
Q705	G3
Q706	G3
Q707	F3
Q708	F3
Q709	F3

Circuit No.	J, U, C, R, T, K, A, L	B, G
R711~714	X	O
SW711~714	X	O

X: NOT USED
O: USED / APPLICABLE

PRINTED CIRCUIT BOARD (Foil side)

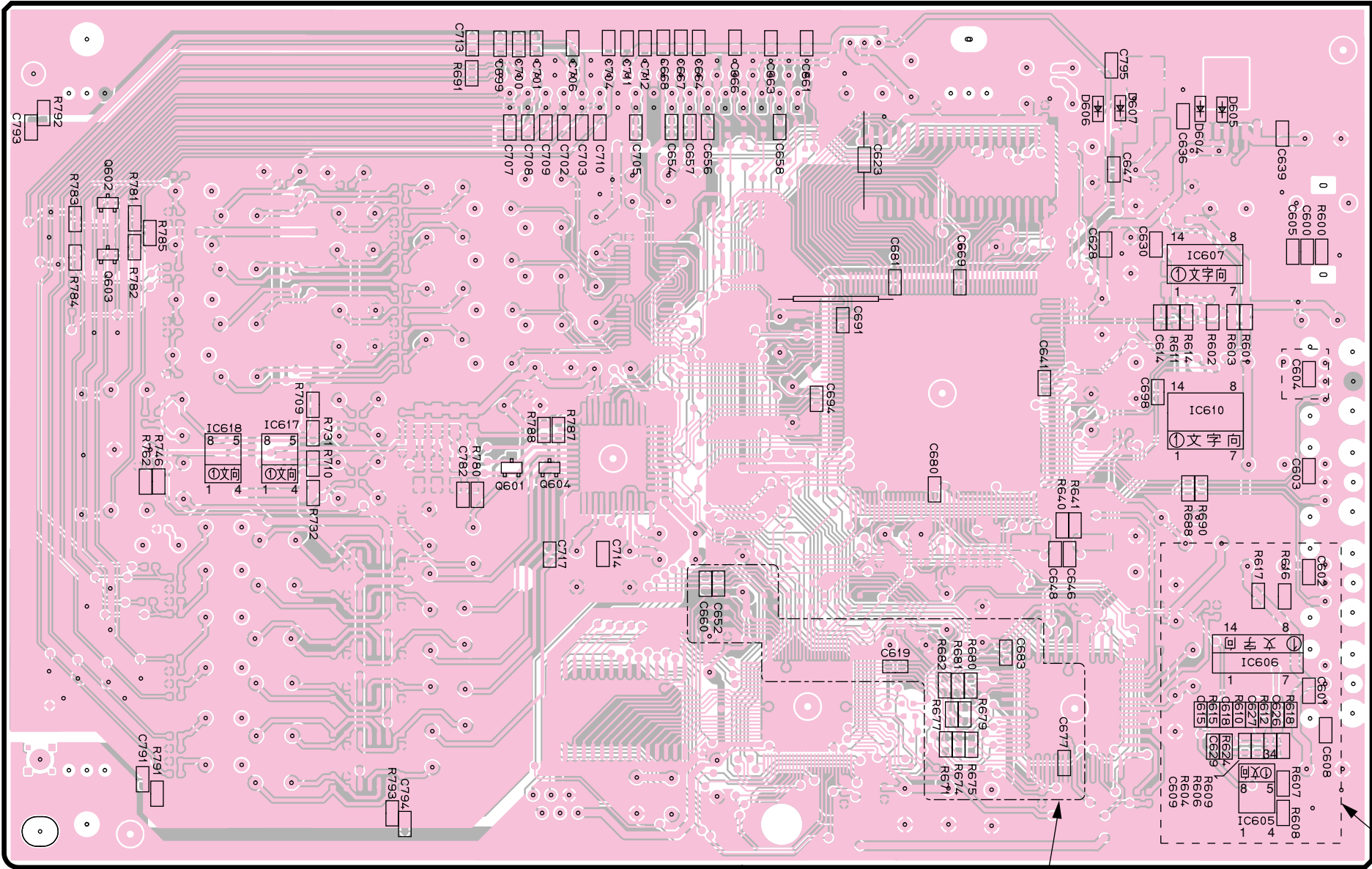
DSP P. C. B. (Surface Mount Device)

Circuit No.	J	U, C, R, T, K, A, B, G
C658, 661, 666	O	X
J601	X	O
R653, 654, 656, 657, 659, 660, 662	O	X
R668	X	O

X: NOT USED
O: USED / APPLICABLE

Semiconductor Location

Ref. No.	Location
D604	F2
D605	F2
D606	F2
D607	F2
IC605	G5
IC606	G5
IC607	F3
IC610	F4
IC617	B4
IC618	B4
Q601	C4
Q602	A2
Q603	A3
Q604	C4



J model only

: RX-V530/RX-V530RDS/
HTR-5550/HTR-5550RDS/
DSP-AX530 only